

HD74HCT240

Octal Buffers/Line Drivers/Line Receivers (with inverted 3-state outputs)

REJ03D0662-0200
(Previous ADE-205-550)
Rev.2.00
Mar 30, 2006

Description

The HD74HCT240 is an inverting buffer and has two active low enables ($\overline{1G}$ and $\overline{2G}$). Each enable independently controls 4 buffers. This device does not have schmitt trigger inputs.

Features

- LSTTL Output Logic Level Compatibility as well as CMOS Output Compatibility
- High Speed Operation: t_{pd} (A to Y) = 11 ns typ ($C_L = 50$ pF)
- High Output Current: Fanout of 15 LSTTL Loads
- Wide Operating Voltage: $V_{CC} = 4.5$ to 5.5 V
- Low Input Current: $1 \mu A$ max
- Low Quiescent Supply Current: I_{CC} (static) = $4 \mu A$ max ($T_a = 25^\circ C$)
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HCT240P	DILP-20 pin	PRDP0020AC-B (DP-20NEV)	P	—
HD74HCT240FPEL	SOP-20 pin (JEITA)	PRSP0020DD-B (FP-20DAV)	FP	EL (2,000 pcs/reel)
HD74HCT240RPEL	SOP-20 pin (JEDEC)	PRSP0020DC-A (FP-20DBV)	RP	EL (1,000 pcs/reel)
HD74HCT240TELL	TSSOP-20 pin	PTSP0020JB-A (TTP-20DAV)	T	ELL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

Function Table

Inputs		Output
$\overline{G}$	A	Y
H	X	Z
L	H	L
L	L	H

H : high level

L : low level

X : irrelevant

Z : off (high-impedance) state of a 3-state output

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V_{CC}	4.5 to 5.5	V	
Input / Output voltage	V_{IN}, V_{OUT}	0 to V_{CC}	V	
Operating temperature	T_a	-40 to 85	°C	
Input rise / fall time ^{*1}	t_r, t_f	0 to 500	ns	$V_{CC} = 4.5\text{ V}$

Notes: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

Electrical Characteristics

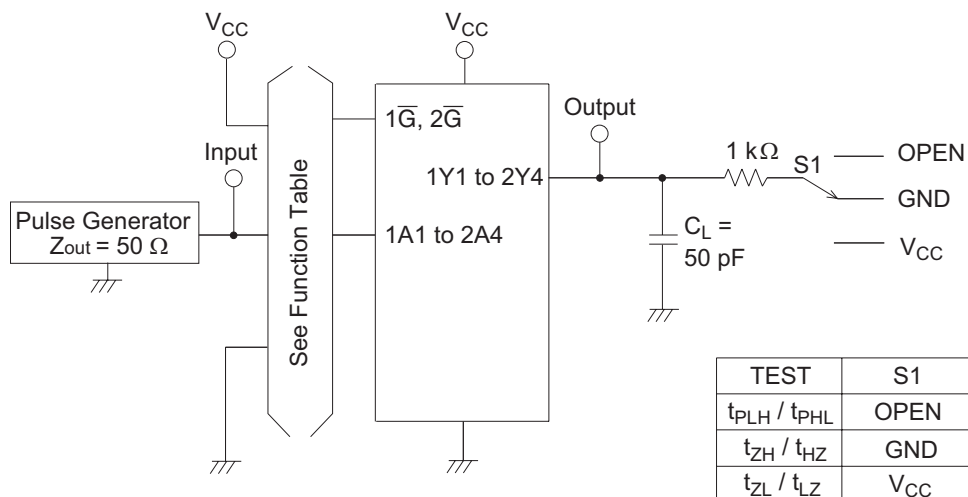
Item	Symbol	V_{CC} (V)	$T_a = 25^\circ\text{C}$			$T_a = -40\text{ to }+85^\circ\text{C}$		Unit	Test Conditions	
			Min	Typ	Max	Min	Max			
Input voltage	V_{IH}	4.5 to 5.5	2.0	—	—	2.0	—	V		
	V_{IL}	4.5 to 5.5	—	—	0.8	—	0.8	V		
Output voltage	V_{OH}	4.5	4.4	—	—	4.4	—	V	$V_{in} = V_{IH}\text{ or }V_{IL}$	$I_{OH} = -20\text{ }\mu\text{A}$
		4.5	4.18	—	—	4.13	—	V		$I_{OH} = -6\text{ mA}$
	V_{OL}	4.5	—	—	0.1	—	0.1	V	$V_{in} = V_{IH}\text{ or }V_{IL}$	$I_{OL} = 20\text{ }\mu\text{A}$
		4.5	—	—	0.26	—	0.33	V		$I_{OL} = 6\text{ mA}$
Off-state output current	I_{OZ}	5.5	—	—	± 0.5	—	± 5.0	μA	$V_{in} = V_{IH}\text{ or }V_{IL}$, $V_{out} = V_{CC}\text{ or GND}$	
Input current	I_{in}	5.5	—	—	± 0.1	—	± 1.0	μA	$V_{in} = V_{CC}\text{ or GND}$	
Quiescent current	I_{CC}	5.5	—	—	4.0	—	40	μA	$V_{in} = V_{CC}\text{ or GND}$, $I_{out} = 0\text{ }\mu\text{A}$	

Switching Characteristics

($C_L = 50\text{ pF}$, Input $t_r = t_f = 6\text{ ns}$)

Item	Symbol	V_{CC} (V)	$T_a = 25^\circ\text{C}$			$T_a = -40\text{ to }+85^\circ\text{C}$		Unit	Test Conditions
			Min	Typ	Max	Min	Max		
Propagation delay time	t_{PHL}	4.5	—	13	20	—	25	ns	
	t_{PLH}	4.5	—	9	20	—	25		
Output enable time	t_{ZL}	4.5	—	14	30	—	38	ns	
	t_{ZH}	4.5	—	12	30	—	38		
Output disable time	t_{LZ}	4.5	—	14	30	—	38	ns	
	t_{HZ}	4.5	—	18	30	—	38		
Output rise/fall time	t_{TLH} t_{THL}	4.5	—	4	12	—	15	ns	
Input capacitance	C_{in}	—	—	5	10	—	10	pF	

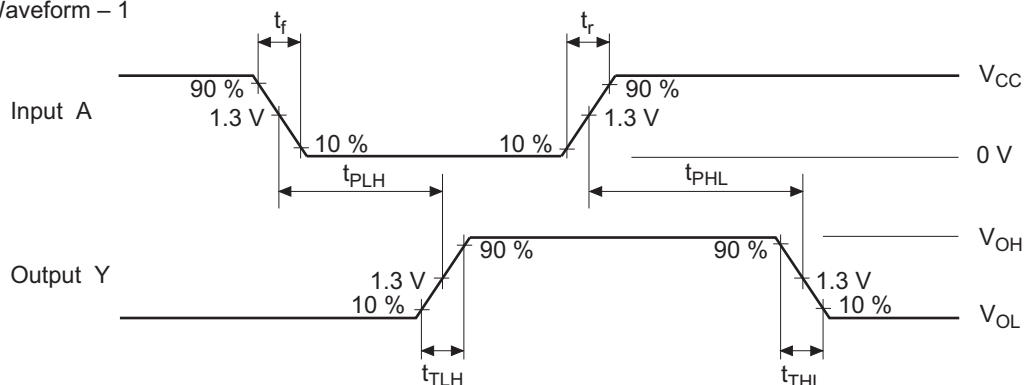
Test Circuit



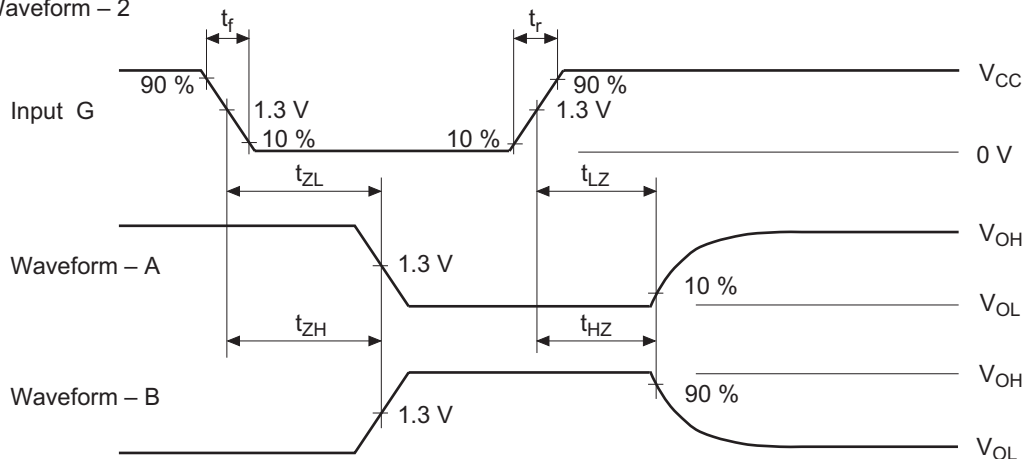
Note : 1. C_L includes probe and jig capacitance.

Waveforms

• Waveform – 1

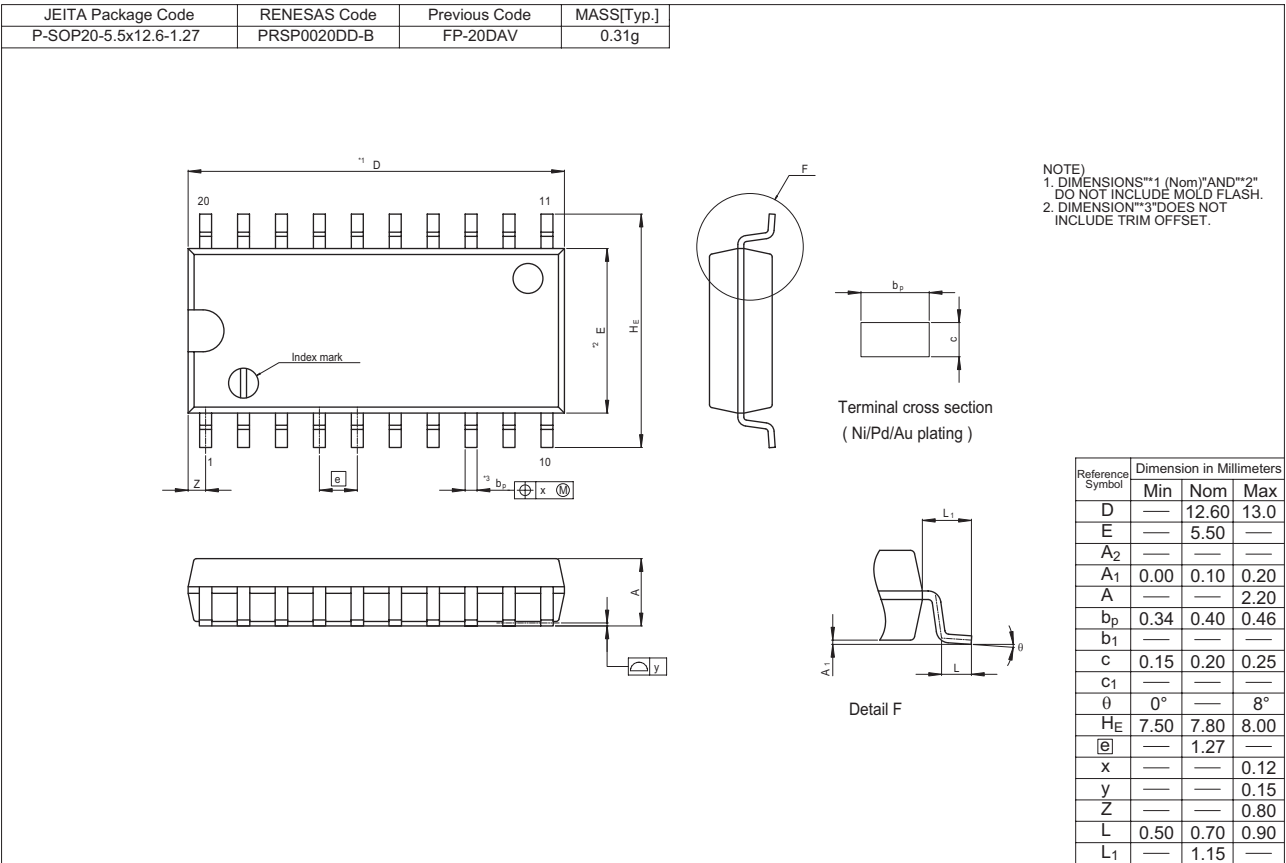
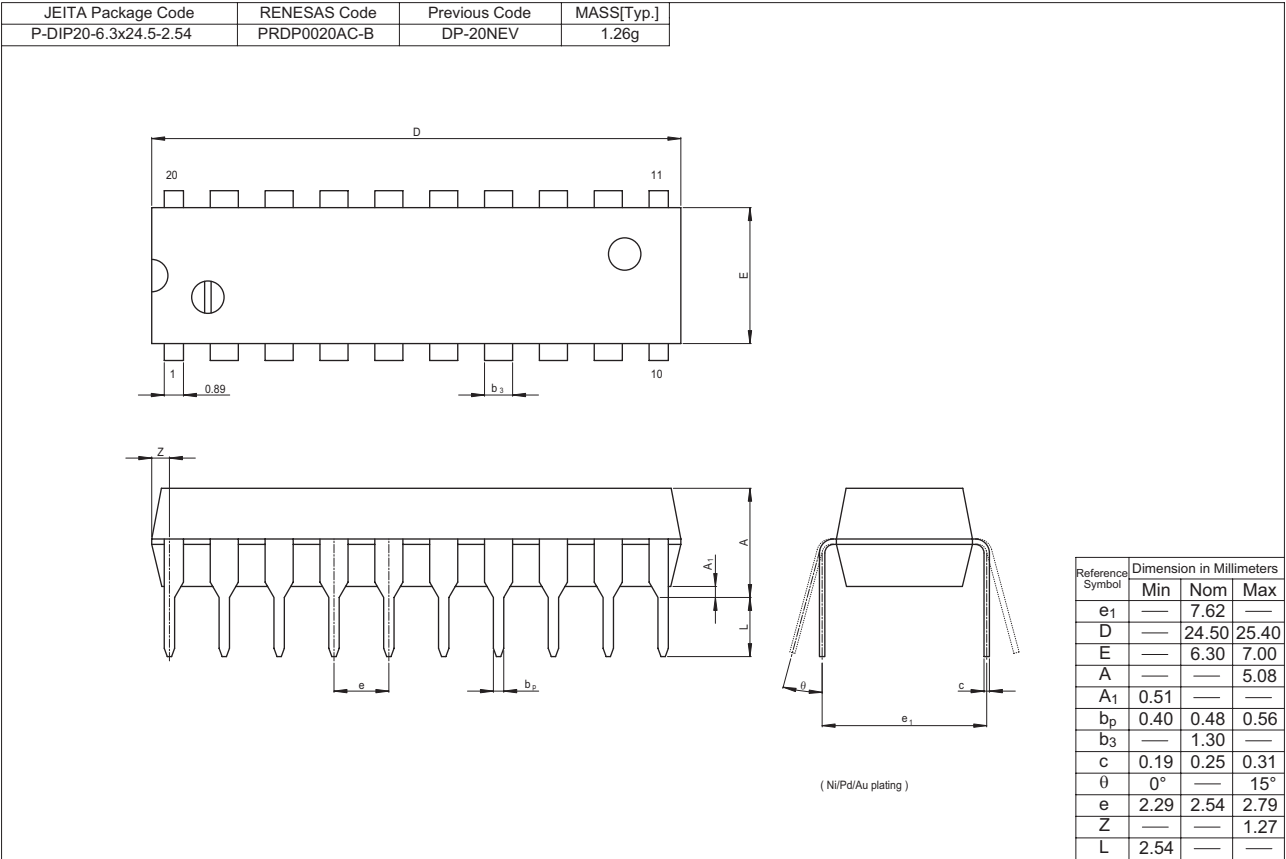


• Waveform – 2

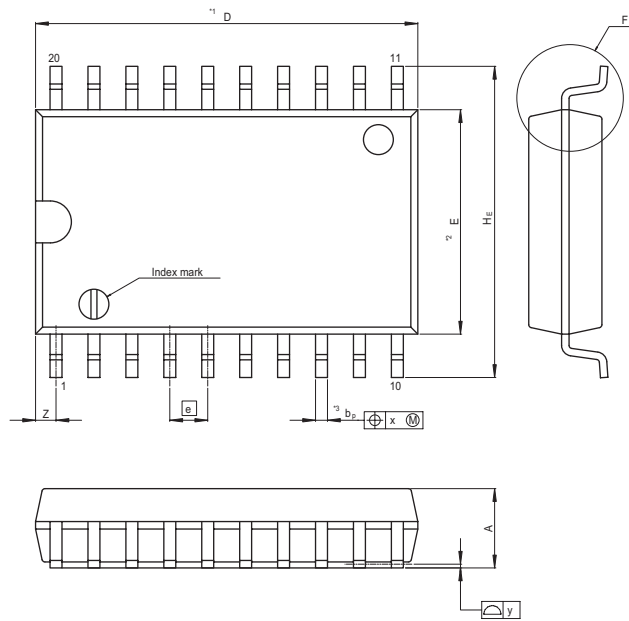


- Notes :
1. Input waveform : $PRR \leq 1 \text{ MHz}$, duty cycle 50%, $t_r \leq 6 \text{ ns}$, $t_f \leq 6 \text{ ns}$
 2. Waveform– A is for an output with internal conditions such that the output is low except when disabled by the output control.
 3. Waveform– B is for an output with internal conditions such that the output is high except when disabled by the output control.
 4. The output are measured one at a time with one transition per measurement.

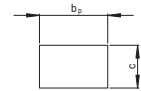
Package Dimensions



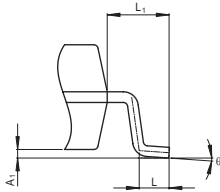
JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-SOP20-7.5x12.8-1.27	PRSP0020DC-A	FP-20DBV	0.52g



NOTE)
1. DIMENSIONS**1 (Nom)**AND**2*
@ DO NOT INCLUDE MOLD FLASH.
2. DIMENSION**3*DOES NOT
@ INCLUDE TRIM OFFSET.



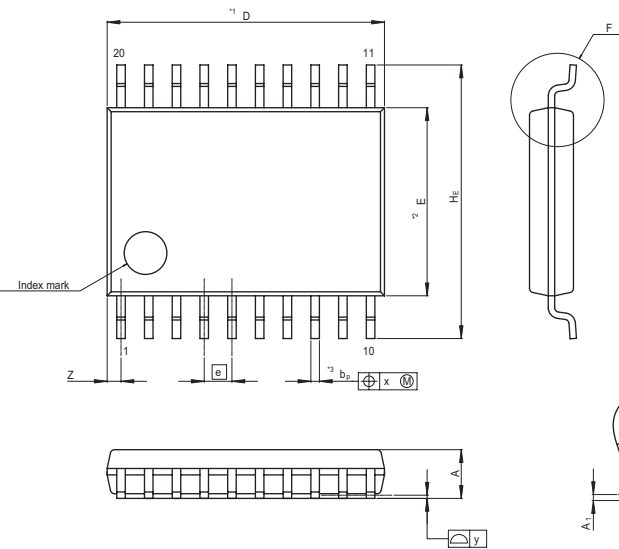
Terminal cross section
(Ni/Pd/Au plating)



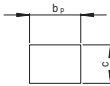
Detail F

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	12.80	13.2
E	—	7.50	—
A ₂	—	—	—
A ₁	0.10	0.20	0.30
A	—	—	2.65
b _p	0.34	0.40	0.46
b ₁	—	—	—
c	0.20	0.25	0.30
c ₁	—	—	—
θ	0°	—	8°
H _E	10.00	10.40	10.65
@	—	1.27	—
x	—	—	0.12
y	—	—	0.15
Z	—	—	0.935
L	0.40	0.70	1.27
L ₁	—	1.45	—

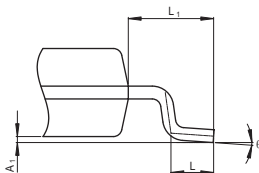
JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-TSSOP20-4.4x6.5-0.65	PTSP0020JB-A	TTP-20DAV	0.07g



NOTE)
1. DIMENSIONS**1 (Nom)**AND**2*
DO NOT INCLUDE MOLD FLASH.
2. DIMENSION**3*DOES NOT
INCLUDE TRIM OFFSET.



Terminal cross section
(Ni/Pd/Au plating)



Detail F

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	—	6.50	6.80
E	—	4.40	—
A ₂	—	—	—
A ₁	0.03	0.07	0.10
A	—	—	1.10
b _p	0.15	0.20	0.25
b ₁	—	—	—
c	0.10	0.15	0.20
c ₁	—	—	—
θ	0°	—	8°
H _E	6.20	6.40	6.60
@	—	0.65	—
x	—	—	0.13
y	—	—	0.10
Z	—	—	0.65
L	0.4	0.5	0.6
L ₁	—	1.0	—

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